IN THE UNITED STATES PATENT AND TRADEMARK OFFICE)

* *) F	examiner:
Yuichiro Shindo et al.)	Adminici.
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Application No.:	j.	•
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Corresponding International Filing No.:	í	
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E HOLLDWING BOURS)	
For: HIGH-PURITY Ru POWDER,)	
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AND PROCESS FOR)	
PRODUCING THE HIGH-PURITY)	
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Mail Stop PCT		
Commissioner for Patents		
P.O. Box 1450		
Alexandria, VA 22313-1450		

In re the Application of:

VERIFICATION OF TRANSLATION

Sir:

I, Isamu Ogoshi, having been warned that willful false statements and the like are punishable by fine or imprisonment or both, under section 1001 of Title 18 of the United States Code, and may jeopardize the validity of the above-captioned application and any patent issuing thereon, declare:

- I am a patent attorney authorized to practice law in Japan and am engaged in the practice of law with OGOSHI International Patent Office at Toranomon 9 Mori Bldg. 3F, 2-2, Atago 1-Chome, Minato-ku, Tokyo 105-0002, Japan.
 - (2) I am fluent in the Japanese and English Languages.
- (3) I have reviewed the attached translation, and certify that it is an accurate English translation of the Japanese language international application of Yuichiro Shindo and Akira Hisano filed on February 2, 2005 and given International Application No. PCT/JP2005/001488.
- (4) All of the statements made herein of my own knowledge are true and all statements made herein on information and belief are believed to be true.

August 29,2006 <u>Banne Ogosla</u>